

# *Dow Corning*<sup>®</sup> TC-5022 Thermally Conductive Compound

## FEATURES

- Flowable
- High thermal conductivity
- Low thermal resistance
- Capable of achieving thin Bond Line Thickness at low pressure
- Reduced pump out during thermal cycling

## BENEFITS

- One part non-curing: No need for curing ovens.
- Conducts heat away from electronic components to improve device reliability

## COMPOSITION

- Polydimethylsiloxane compound

Gray, flowable non-curing thermally conductive compound

## APPLICATIONS

- Thermal interface material for electronic device cooling.

## TYPICAL PROPERTIES

Specification Writers: These values are not intended for use in preparing specifications. Please contact your local Dow Corning sales office or your Global Dow Corning Connection before writing specifications on this product.

Property	Unit	Result
One part or Two part		One
Color		Gray
Viscosity	cP Pa-sec	82375 82.4
Thixotropy	NA	16.1
Specific Gravity (Uncured)	-	3.23
NVC (Non Volatile Content)	%	99.95
Thermal Conductivity	btu/hr ft degF W/mK	2.832 4
Thermal Resistance at 40 psi	°C*cm <sup>2</sup> /W	0.06
Dielectric Strength	volts/mil kV/mm	75 3
Dissipation Factor at 1kHz	-	0.5621
Dielectric Constant at 1kHz	-	18.05
Volume Resistivity	ohm*cm	4.85E10

## DESCRIPTION

*Dow Corning*<sup>®</sup> brand thermally conductive compounds are grease like silicone materials, heavily filled with heat-conductive metal oxides. This combination promotes high thermal conductivity, low bleed and high-temperature stability. The compounds are designed to maintain a positive heat sink seal to improve heat transfer from the electrical/electronic device to the heat sink or chassis, thereby increasing the overall efficiency of the device. Electronic devices are

continually designed to deliver higher performance. Especially in the area of consumer electronics, there is also a continual trend towards smaller, more compact designs. In combination these factors typically mean that more heat is generated in the device. Thermal management of electronic devices is a primary concern of design engineers. A cooler device allows for more efficient operation and better reliability over the life of the device. As such, thermally conductive compounds play an integral role here.



Thermally conductive materials act as a thermal “bridge” to remove heat from a heat source (device) to the ambient via a heat transfer media (i.e. heat sink). These materials have properties such as low thermal resistance, high thermal conductivity, and can achieve thin Bond Line Thicknesses (BLTs) which can help to improve the transfer of heat away from the device. Thermal greases have advantage over other TIMs due to their relatively low cost, ease of application on to heat sinks (screen printing), and ease of re-work.

## APPLICATION METHODS

- Screen print
- Stencil print
- Dispense

## HOW TO USE

Allow printed grease pad to dry open for 24 hours before assembly. Dry time allows the small amount of carrier fluid to evaporate.

## SOLVENT EXPOSURE

In general, the product is resistance to minimal or intermittent solvent exposure, however best practice is to avoid solvent exposure altogether.

## USABLE LIFE AND STORAGE

The product should be stored in its original packaging with the cover tightly attached to avoid any contamination. Store in accordance with any special instructions listed on the product label. The product should be used by the indicated Exp. Date found on the label.

## HANDLING

### PRECAUTIONS

**PRODUCT SAFETY INFORMATION REQUIRED FOR SAFE USE IS NOT INCLUDED IN THIS DOCUMENT. BEFORE HANDLING, READ PRODUCT AND MATERIAL SAFETY DATA SHEETS AND CONTAINER LABELS FOR SAFE USE, PHYSICAL AND HEALTH HAZARD INFORMATION. THE**

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## LIMITATIONS

This product is neither tested nor represented as suitable for medical or pharmaceutical uses.

## HEALTH AND ENVIRONMENTAL INFORMATION

To support Customers in their product safety needs, Dow Corning has an extensive Product Stewardship organization and a team of Product Safety and Regulatory Compliance (PS&RC) specialists available in each area.

For further information, please see our Web site, [dowcorning.com](http://dowcorning.com) or consult your local Dow Corning representative.

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